

## MRS Spring Meeting 2018 熱電シンポジウムのお知らせ

国際交流委員会委員長  
森 孝雄

熱電材料関連のシンポジウムが開催される MRS Spring Meeting 2018 のお知らせです。奮ってご参加下さい。  
次ページに HP のご案内がございます。

国際会議名 : MRS Spring Meeting 2018  
Symposium EN10

日時 : 2017 年 4 月 2 日～4 月 6 日

場所 : Phoenix, USA

ホームページ :

(全体) <https://www.mrs.org/spring2018>  
(熱電関連シンポジウム、Symposium EN10)

<https://www.mrs.org/spring-2018-call-for-papers/call-for-papers-detail/?code=EN10>

アブストラクト切 : 10 月 31 日 2017 年

**TMS 2018**  
147<sup>th</sup> Annual Meeting & Exhibition  
THE WORLD COMES HERE.

MARCH 11 - 15, 2018  
PHOENIX, ARIZONA

Meeting Home  
tms.org

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**MEETING NEWS**  
Request a Visa Invitation Letter  
Posted on: June 26, 2017

Many TMS2018 presenters will travel to Phoenix, Arizona, from other countries to attend TMS2018. Those presenters who require a travel visa to enter the United States are encouraged to [request a visa invitation letter](#) now and to begin the process of applying for a travel visa today.

## CALL FOR PAPERS

### Alloys and Compounds for Thermoelectric and Solar Cell Applications VI

2018 TMS Annual Meeting at Phoenix, Arizona  
March 11 - March 15, 2018

This symposium addresses synthesis, property measurements, phase stability, phase transformation of the alloys and compounds used in the thermoelectric and solar cell devices. Materials of interests include, but not limited to, skutterudites, superlattice, half-Heusler alloys, CdTe, CIS, CIGS, CZTS and new materials for thermoelectric and solar cell applications. Abstracts are due by July 1<sup>st</sup>, 2017. Please submit abstracts directly to TMS Online.

(<http://www.tms.org/tms2018>)

(<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>).

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